

TOSHIBA GTR MODULE SILICON N CHANNEL IGBT

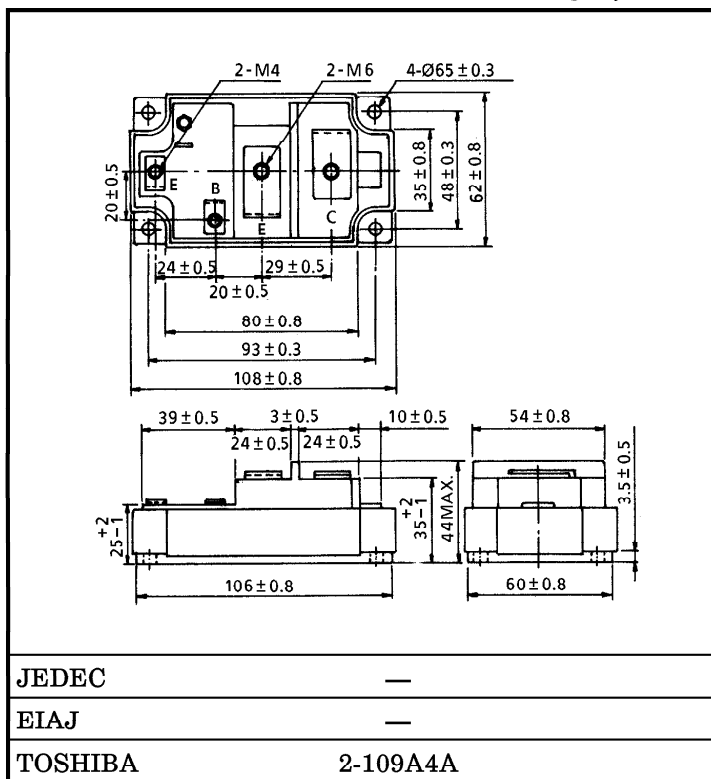
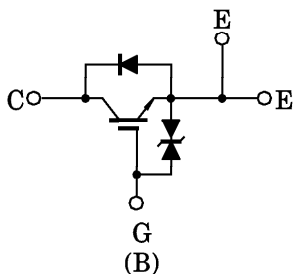
MG200Q1US41

HIGH POWER SWITCHING APPLICATIONS
MOTOR CONTROL APPLICATIONS

Unit in mm

- High Input Impedance
- High Speed : $t_f = 0.5 \mu s$ (Max.)
: $t_{rr} = 0.5 \mu s$ (Max.)
- Low Saturation Voltage
: $V_{CE(sat)} = 4.0V$ (Max.)
- Enhancement-Mode
- The Electrodes are Isolated from Case.

EQUIVALENT CIRCUIT



Weight : 465g

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Collector-Emitter Voltage		V_{CES}	1200	V
Gate-Emitter Voltage		V_{GES}	±20	V
Collector Current	DC	I_C	200	A
	1ms	I_{CP}	400	
Forward Current	DC	I_F	200	A
	1ms	I_{FM}	400	
Collector Power Dissipation (Tc = 25°C)		P_C	1400	W
Junction Temperature		T_j	150	°C
Storage Temperature Range		T_{stg}	-40~125	°C
Isolation Voltage		V_{Isol}	2500 (AC, 1 min.)	V
Screw Torque (Terminal : M4 / M6 / Mounting)		—	2 / 3 / 3	N·m

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I _{GES}	V _{GE} = ±20V, V _{CE} = 0	—	—	±40	μA
Collector Cut-off Current		I _{CES}	V _{CE} = 1200V, V _{GE} = 0	—	—	4.0	mA
Gate-Emitter Cut-off Voltage		V _{GE (OFF)}	I _C = 200mA, V _{CE} = 5V	3.0	—	6.0	V
Collector-Emitter Saturation Voltage		V _{CE (sat)}	I _C = 200A, V _{GE} = 15V	—	3.0	4.0	V
Input Capacitance		C _{ies}	V _{CE} = 10V, V _{GE} = 0, f = 1MHz	—	24000	—	pF
Switching Time	Rise Time	t _r		—	0.3	0.6	μs
	Turn-on Time	t _{on}		—	0.4	0.8	
	Fall Time	t _f		—	0.2	0.5	
	Turn-off Time	t _{off}		—	0.8	1.5	
Forward Voltage		V _F	I _F = 200A, V _{GE} = 0	—	2.0	3.0	V
Reverse Recovery Time		t _{rr}	I _F = 200A, V _{GE} = -10V di / dt = 300A / μs	—	0.25	0.5	μs
Thermal Resistance		R _{th(j-c)}	Transistor	—	—	0.089	°C / W
			Diode	—	—	0.25	

